VP-29MC-M/C 5

Thermoelectric Peltier Cooled High Speed Programmable Digital Camera





VP Series cameras are thermo – electric Peltier (TEC) cooled high performance digital cameras. These cameras use cooling technology developed for and used by many demanding medical market customers. The TEC maintains the operating temperature of the CCD at up to 20 degrees below ambient temperature. These cameras provide a stable operating condition and the ability to expose for a long period of time to increase camera sensitivity. These cameras are ideal for industrial applications such as FPD inspection and microscopy.



- Thermoelectric Peltier Cooled
- 20 degrees below ambient temperature
- Progressive Scan Interline Transfer CCD Imager
- Flat Field Correction
- Pixel Defect Correction
- Field Upgradable Firmware

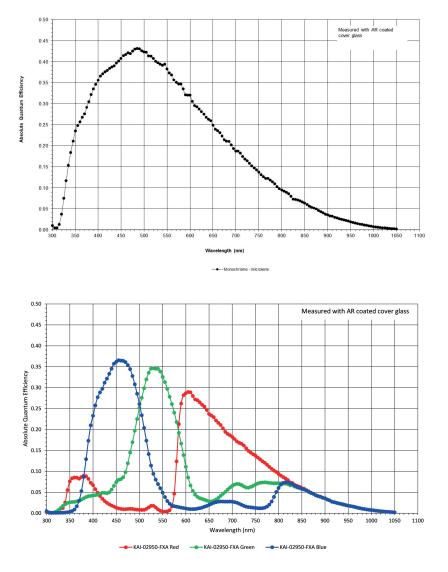
Applications

- Flat Panel Display Inspection
- Research and Scientific Imaging
- Machine Vision Inspection
- Microscopy and Metrology

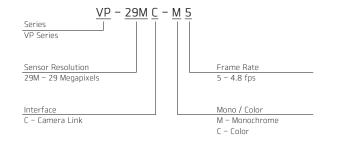
Specifications

Model	VP-29MC-M/C 5	
Resolution (H $ imes$ V)	6576 × 4384	
Sensor (ON Semiconductor)	KAI-29050	
Sensor Size (Optical Format)	35 mm	
Sensor Type	Progressive Scan Interline Transfer CCD	
Pixel Size	5.5 μ m $ imes$ 5.5 μ m	
Interface	Camera Link	
Max. Frame Rate (40 MHz)	4.8 fps	
Exposure Time (10 µs step)	1/100000 s - 7 s	
Partial Scan (Max. Speed)	15.2 fps at 1000 Lines	
Pixel Data Format	8 / 10 / 12 bit	
Electronic Shutter	Global Shutter	
Data Output Pixel Clock	40/80 MHz	
Trigger Mode	Free-Run, Overlap, Fast, Double – Programmable Exposure Time and Trigger Polarity	
Dynamic Range	62 dB	
Cooling Method	Thermoelectric Peltier Cooling	
Cooling Performance	20°C below ambient temperature Standard cooling with a fan	
Dimension / Weight	90 mm $ imes$ 90 mm $ imes$ 142 mm, 1550 g (with F-mount)	
Temperature	Operating: −5°C ~ 40°C Storage: −40°C ~ 70°C	
Lens Mount	No mount or F-mount, Custom mount available upon request	
Power	10~14 V DC, Typ. 26 / Max. 30 W	
Compliance	CE, FCC, KC	
Configuration Software	Configurator	

Quantum Efficiency Curves



Ordering Scheme



Connector Specification

Power

Control



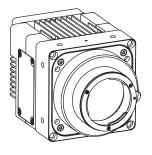
1, 2, 3: +12V DC 4, 5, 6: GND (HR10A-7R-6PB)

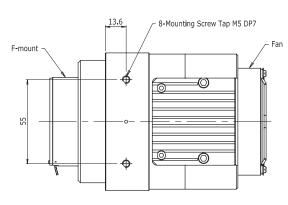
1: Trigger IN+ 3: Strobe OUT-(GND) 4: Strobe OUT+ (HR10A-7R-4S)

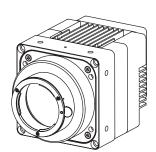
Connectors on camera body

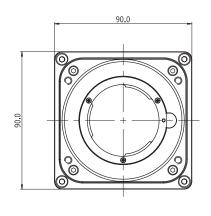
2: Trigger IN–

Unit: mm

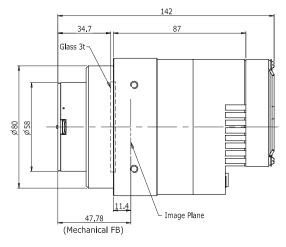




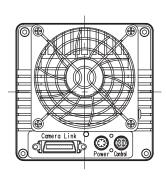




<Front View>



<Side View>



<Back Vlew>



For more information please contact:

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41-3, Burim-ro 170 beon-gil, Dongan-gu, Anyang-si, Gyeonggi-do, 14055 Republic of Korea Tel +82-70-7011-6161 Fax +82-31-386-8631 E-mail vision@vieworks.com Web www.vieworks.com

VA-29MC2-M/C 6

29 Megapixel Resolution High Speed Programmable Digital Camera





The new 29 megapixel progressive scan high performance CCD camera, VA–29MC2–6, is a new member of industrial proven VA Camera Link series. Equipped with the Vieworks' innovative technologies proved by world's top FPD manufacturers, VA–29MC2–6 offers not only high uniformed images but also high speed image processing capabilities. This camera supports 29 megapixel resolution with frame rate up to 6.1 fps. Featured with high quality image uniformity and high resolution, the camera is ideal for demanding applications such as FPD, PCB and semiconductor inspections.



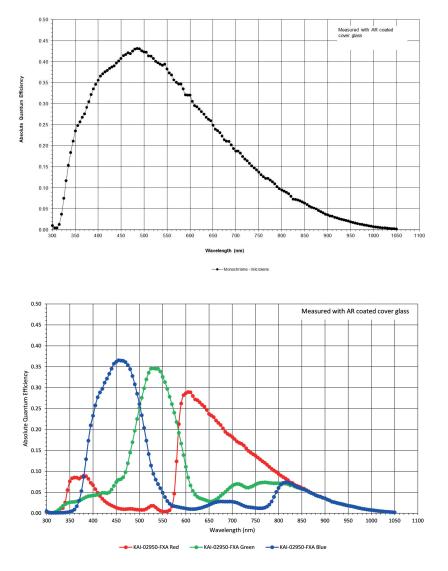
- 29 Megapixel Resolution
- Progressive Scan Interline Transfer CCD Imager
- 8 / 10 / 12 bit Data Output
- Up to 6.1 fps with Camera Link Medium Configuration
- Global Shutter
- Flat Field Correction
- Pixel Defect Correction
- Field Upgradable Firmware

Specifications

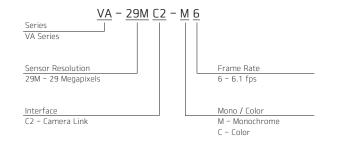
- FPD, Electronics and Semiconductor Inspection
- Research and Scientific Imaging
- Microscopy and Metrology

ModelVA-29MC2-M/C 6Resolution (H × V)6576 × 4384SensorSensor (DH = V)Sensor Size (Optical Format)36.17 mm × 24.11 mm (35 mm)Sensor TypeProgressive Scan Interline Transfer CCDPixel Size5.5 μ m × 5.5 μ mSensor Output1, 2 or 4 TapInterfaceCamera LinkMax. Frame RateNormal Speed: 4.8 fps (Camera Link Medium Configuration)Max. Frame RateNormal Speed: 4.8 fps (Camera Link Medium Configuration)Partial Scan (Max. Speed)18 fps at 1000 LinesPixel Data Format1, 2 TapNormal: 40 Met / High: 52 MetPixel Clock Speed1, 2 TapNormal: 80 Met / High: 52 MetPixel Clock Speed1, 2 TapNormal: 80 Met / High: 52 MetPixel Clock Speed5.7 metSensor Clock Speed1, 2 TapNormal: 80 Met / High: 52 MetPixel Clock Speed4 TapSensor Clock Speed5.7 metSensor Clock Speed1, 2 TapAnalog Glf=Adjustable (0 ~ 127 LSB at 12 bit, 256 steps)Analog Gli0 ~ 32 dB, 900 steps
SensorON Semiconductor KAI-29050Sensor Size (Optical Format)36.17 mm × 24.11 mm (35 mm)Sensor TypeProgressive Scan Interline Transfer CCDPixel Size5.5 µm × 5.5 µmSensor Output1, 2 or 4 TapInterfaceCamera LinkMax. Frame RateNormal Speed: 4.8 fps (Camera Link Base Configuration)Kax. Frame Rate1 µs ~ 60 s (10 µs step)Partial Scan (Max. Speed)18 fps at 1000 LinesPixel Data Format8 / 10 / 12 bitElectronic ShutterGlobal ShutterData Output1, 2 TapPixel Clock Speed4 TapPixel Clock Speed4 TapSprame RateSensor Rate Rate Rate Rate Rate Rate Rate Rate
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Global ShutterElectronic ShutterGlobal ShutterData Output1, 2 TapNormal: 40 Mt/ High: 52 Mt/Pixel Clock Speed4 TapNormal: 80 Mt/ High: 52 Mt/Trigger Mode4 TapFree-Run, Standard, Fast, Double, Overlap Programmable Exposure Time and Trigger PolarityDynamic Range64 dBBinning×1, ×2, ×4 (Horizontal and Vertical Independent)Gamma CorrectionUser Defined Lookup Table (LUT)Analog OffsetAdjustable (0 ~ 127 LSB at 12 bit, 256 steps)Analog Gaint0 ~ 32 dB, 900 steps
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Gamma CorrectionUser Defined Lookup Table (LUT)Analog OffsetAdjustable (0 ~ 127 LSB at 12 bit, 256 steps)Analog Gain0 ~ 32 dB, 900 steps
Analog OffsetAdjustable (0 ~ 127 LSB at 12 bit, 256 steps)Analog Gain0 ~ 32 dB, 900 steps
Analog Gain0 ~ 32 dB, 900 steps
Dimension / Weight $68 \text{ mm} \times 68 \text{ mm} \times 102 \text{ mm}$, 500 g (with F-mount)
Temperature Operating: −5°C ~ 40°C, Storage: −40°C ~ 70°C
Lens Mount F-mount, Custom mount available upon request
Power 10 ~ 14 V DC, Typ. 9.5 W
Compliance CE, FCC, KC
Configuration Software Configurator

Quantum Efficiency Curves



Ordering Scheme



Connector Specification



1, 2, 3: +12V DC 4, 5, 6: GND (HR10A-7R-6PB)

1: Trigger IN+

3: DC Ground

(HR10A-7R-4S)

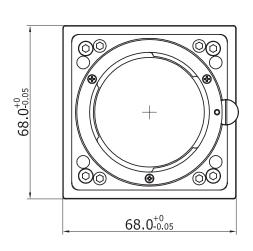
Control

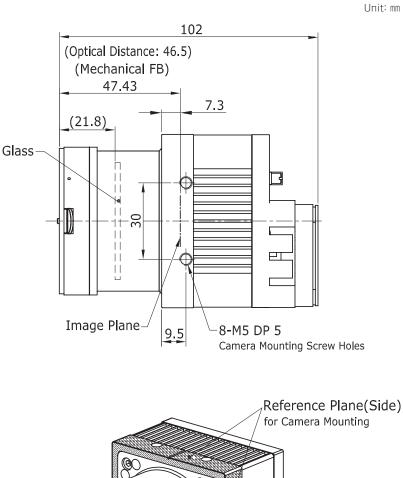
Power

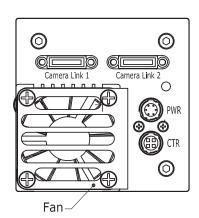


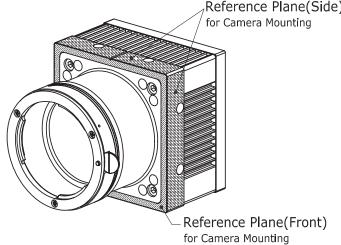
2: Trigger IN– 4: Strobe OUT+

Connectors on camera body









For more information please contact:

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VP-101MC-M/C 8 H VP-151MC-M/C 5 H

High Resolution Thermoelectric Peltier Cooled Camera



The VP-101MC and VP-151MC, the latest models of the industrial proven VP series, are 101 and 151 megapixel resolution CMOS cameras available with the Camera Link interface. These cameras are based on the latest CMOS image sensor technology (IMX461 and IMX411) from Sony Semiconductor Solutions Corporation. The VP-101MC-8 offers up to 8.1 frames per second at 11648 \times 8742 resolution. For even higher resolution applications, the VP-151MC-5 offers up to 5.5 frames per second at 14192 \times 10640 resolution. These cameras use thermo-electric Peltier (TEC) cooling technology developed for and used by many demanding medical market customers. The TEC maintains the operating temperature of the CMOS image sensor at up to 15 degrees below ambient temperature. These cameras provide a stable operating condition and the ability to expose for a long period of time to increase camera sensitivity. Featured with the stable operating capability and high resolution, these cameras are ideal for demanding applications such as FPD, PCB and semiconductor inspections.



- Thermoelectric Peltier Cooled 15°C below
- 101 or 151 Megapixel Resolution
- Camera Link Full Interface
- Electronic Rolling Shutter
- DSNU and PRNU Correction
- Flat Field Correction with Sequencer Control
- Hot Pixel Correction
- Dynamic Defective Pixel Correction
- 4 Gb Frame Buffer for Burst Readout Mode

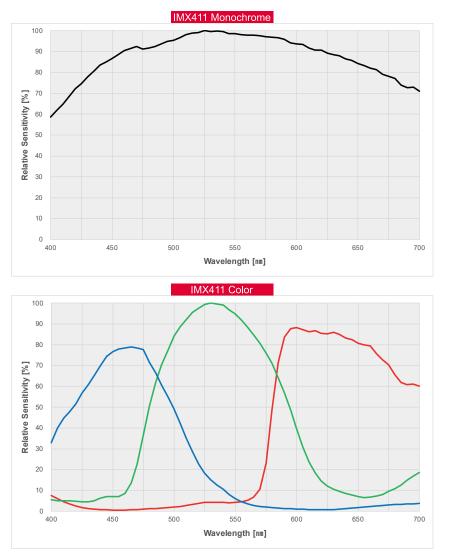
Specifications

- Flat Panel Display Inspection
- Electronics Inspection
- Semiconductor Inspection
- Document / Film Scanning

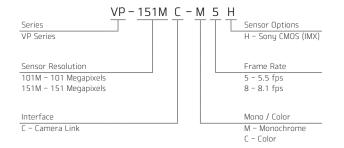
Model		VP-101MC-M/C 8 H	VP-151MC-M/C 5 H	
Resolutio	n (H $ imes$ V)	11648 × 8742	14192 × 10640	
Sensor		SONY IMX461	SONY IMX411	
Sensor Size	e (Diagonal)	43.80 mm \times 32.87 mm (55 mm)	53.36 mm \times 40.01 mm (66.7 mm)	
Pixel	Size	3.76 µm × 3.76 µm		
Inter	face	Camera Link Base / Medium / Full / 10 Tap, 26-pin SDR Connector		
Max. Fra	ime Rate	8.1 fps (with Overlapped Acquisition)	5.5 fps (with Overlapped Acquisition)	
Camera Ima	age Memory	4 Gb		
Exposure Tin	ne (1 µs step)	1 <i>µ</i> s – 60 s		
Binning	Sensor	imes1, $ imes$ 3 (Horizontal and Vertical Dependent)		
DITITITY	Logic	\times 1, \times 2, \times 4 (Horizontal and Vertical Independent)		
Pixel Dat	a Format	8/10/12 bit		
Data Output Pixel Clock Speed		65 MHz / 85 MHz		
Electronic Shutter		Rolling Shutter		
Trigger	Overlapped Acquisition	Free-Run		
Synchronization	Non-overlapped Acquisition	Hardware Trigger or CC1		
Dynami	c Range	78 dB		
Gain Control		1×~32×		
Black Level Control		0 ~ 255 LSB at 12 bit		
Cooling Method Thermoelectric Peltier Cooling		Peltier Cooling		
Cooling Performance 15°C below ambient temperature – Standard cooling with a fan		re – Standard cooling with a fan		
Dimension / Weight 100 mm ×		100 mm $ imes$ 100 mm $ imes$ 88 mm, 1.1 kg (with M-72 mount)	110 mm $ imes$ 110 mm $ imes$ 88 mm, 1.4 kg (with M-72 mount)	
Tempe	Temperature Operating: 0°C ~ 40°C, Storage: −40°C ~ 70°C		Storage: −40°C ~ 70°C	
Lens Mount M72–mount, Custom mount available upon request		int available upon request		
Power	External	11 ~ 24 V DC		
POWer	Dissipation	Тур. 2	6.0 W	
Compliance		CE, FCC, KC		
API SDK		Vieworks Imaging Solution 7.X		

High Resolution Thermoelectric Peltier Cooled Camera

Relative Sensitivity Curves



Ordering Scheme



Connector Specification

Power

Control



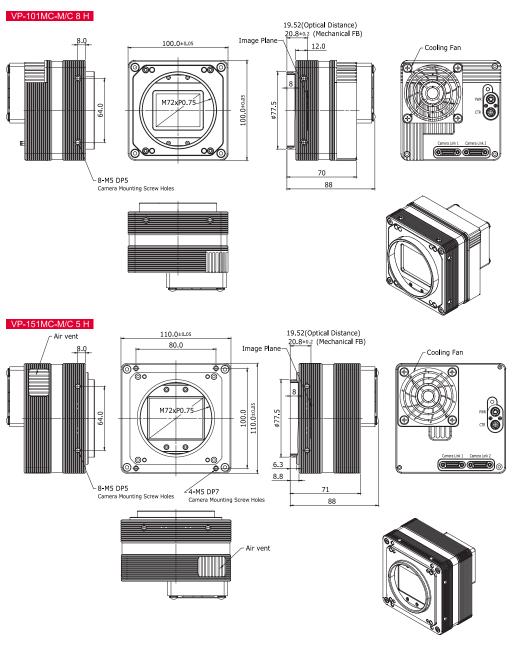
4, 5, 6: GND (HR10A-7R-6PB)

1, 2, 3: +12V DC



1: Trigger IN+ 2: Trigger IN-3: Strobe Out-(GND) 4: Strobe OUT+ (HR10A-7R-4S)

Connectors on camera body



For more information please contact:

Unit: mm

BOCK OPTRONICS INC. 14 Steinway Blvd., Unit 7 Toronto, Ontario M9W 6M6

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41–3, Burim–ro 170 beon–gil, Dongan–gu, Anyang–si, Gyeonggi–do, 14055 Republic of Korea Tel +82–70–7011–6161 Fax +82–31–386–8631 E-mail vision@vieworks.com Web www.vieworks.com

VP-71MC-M/C 4

71 MEGAPIXEL RESOLUTION CMOS CAMERA WITH TEC INTEGRATED



The VP–71MC, the latest member of the industrial proven VP series, is a new 71 megapixel resolution CMOS camera with Camera Link interface. The VP–71MC uses the latest 71 megapixel CMOS imaging sensor (CHR 70M) technology from CMOSIS, and offers a frame rate of 4 fps at full resolution.

This camera uses thermo-electric Peltier (TEC) cooling technology developed for, and used by, many demanding medical market customers. The TEC maintains the operating temperature of the CMOS imaging sensor at up to 20 degrees below ambient temperature. This camera provide a stable operating condition or the ability to expose for a long period of time to increase camera sensitivity. Featured with the stable operating capability and high resolution, this camera is ideal for demanding applications such as FPD, PCB, and semiconductor inspections.



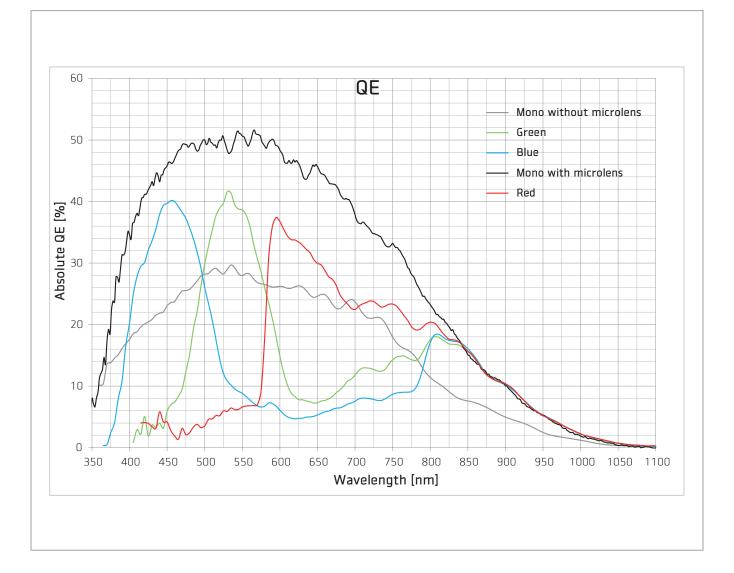
- * Thermoelectric Peltier Cooled 20℃ below ambient temperature
- * 71 Megapixel Resolution CMOS Imaging Sensor
- * Camera Link Medium Interface up to 4.2 fps
- * Minimizing the Number of Hot Pixels with TEC (up to 99%)
- * Flat Field Correction
- * Pixel Defect Correction
- * Non-uniformity Correction (DSNU and PRNU)
- * Field Upgradable Firmware

Specifications

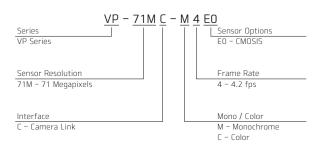
- * FPD, Electronics and Semiconductor Inspection
- * Research and Scientific Imaging
- * Document / Film Scanning

Model			VP-71MC-M/C 4	
Resolu	ition (H	\times V)	10000 × 7096	
:	Sensor		CMOSIS CHR70M	
Sensor Size	e (Optic	al Format)	31.00 mm $ imes$ 24.11 mm (38 mm)	
Ser	nsor Ty	ре	High Resolution CMOS Imaging Sensor	
р	ixel Sizo	2	3.1 μ m $ imes$ 3.1 μ m	
	2 Тар		Camera Link Base	
Interface	4 Tap -	- Normal	Compute Link Medium	
	4 Tap -	- High	Camera Link Medium	
			2.1 fps (CL Base)	
Max.	Frame	Rate	2.9 fps (CL Medium)	
			4.2 fps (CL Medium / Overclocked)	
Transfer Time			476 ms (CL Base)	
		me	335 ms (CL Medium)	
			238 ms (CL Medium / Overclocked)	
Exposure Time		ime	66 µs ~ 7 s (1 line step)	
Pixel Data Format		rmat	8 / 10 / 12 bit	
Electr	onic Sh	utter	Rolling Shutter	
Data Output	put	2 Тар	85 MHz	
Pixel Clock S		4 Тар	Normal: 60 MHz / High: 85 MHz	
Trig	gger Mc	ode	Free-Run, External Trigger Programmable Exposure Time and Trigger Polarity	
Dynamic Range		inge	63 dB	
Cooling Method		hod	Thermoelectric Peltier Cooling	
Cooling Performance		mance	About 20 below ambient temperature – Standard Cooling with a Fan	
Dimension / Weight		Veight	90 mm × 90 mm × 137 mm, 1500 g (F-mount)	
Temperature		ire	Operating: 0°C ~ 40°C, Storage: −40°C ~ 70°C	
Lens Mount		nt	F-mount, Custom mount available upon request	
Power			10 ~ 24 V DC, Typ. 20.0 W	
Co	Compliance		CE, FCC, KC	
Configuration Software		oftware	Configurator	

Quantum Efficiency Curves



Ordering Scheme



Connector Specification

Power

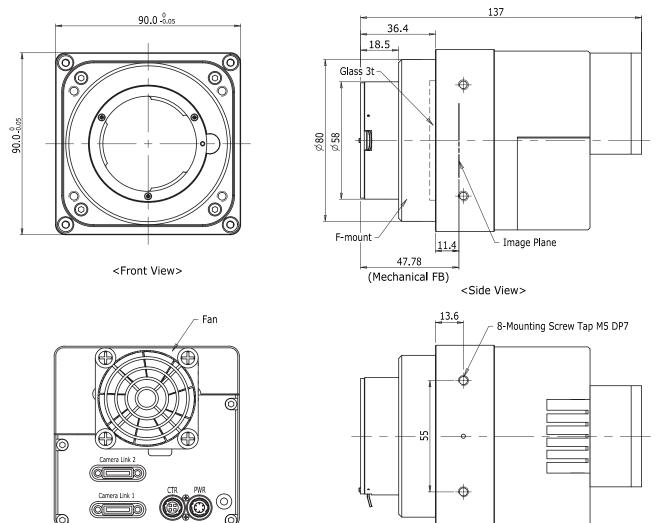


1 2 3: +12V DC, 4 5 6: GND (HR10A-7R-6PB)

1: Trigger IN+, 2: Trigger IN– 3: DC Ground, 4: Strobe OUT+ (HR10A-7R-4S)

Connectors on camera body

Unit: mm



<Back View>

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VW40-162-004



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VP-65MX-M/C 31 I

65 Megapixel Thermoelectric Peltier Cooled Camera



The VP-65MX-31 I, the latest model of the industrial proven VP series, is a new 65 megapixel CoaXPress camera featuring the latest CMOS image sensor technology (GMAX3265) from Gpixel. The VP-65MX-31 I offers up to 31.6 frames per second at 9344 \times 7000 resolution. This camera uses thermo-electric Peltier (TEC) cooling technology developed for and used by many demanding medical market customers. The TEC maintains the operating temperature of the CMOS image sensor at up to 15 degrees below ambient temperature. This camera provides a stable operating condition and the ability to expose for a long period of time to increase camera sensitivity. Featured with the stable operating capability and high resolution, this camera is ideal for demanding applications such as FPD, PCB and semiconductor inspections.



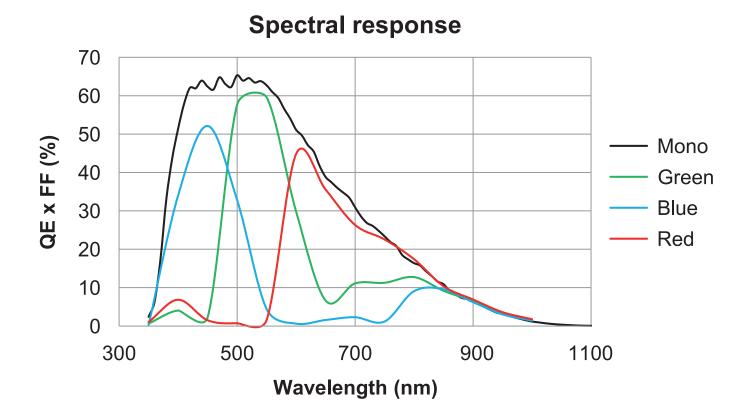
- Thermoelectric Peltier Cooled 15°C below
- 65 Megapixel Resolution
- CoaXPress Interface up to 31.6 fps at 25 Gbps using 4 CH
- Global Shutter CMOS Technology
- DSNU and PRNU Correction
- Flat Field Correction
- Defective Pixel Correction
- GenlCam Compatible XML based Control

Specifications

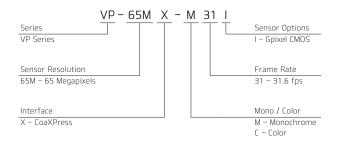
- Flat Panel Display Inspection
- Electronics Inspection
- Semiconductor Inspection
- Document / Film Scanning

Model		VP-65MX-M/C 31 I
Resolution (H \times V)		9344 × 7000
Sensor		Gpixel GMAX3265 – Normal Speed
Sensor Size (D	iagonal)	29.9 mm $ imes$ 22.4 mm (37.4 mm)
Pixel Siz	2e	3.2 μ m $ imes$ 3.2 μ m
Interfac	е	CoaXPress
		4 CH: 31.6 fps @ 8 bit
Max. Frame	Dato	4 CH: 27.3 fps @ 10 bit
IVIAX. FI diffe	nale	4 CH: 24.1 fps @ 12 bit
		4 CH: 31.6 fps @ 8 bit 2 $ imes$ 2 Binning
Exposure Time (1 µs step)		14 <i>µ</i> s - 60 s
Partial Scan (Max. Speed)		6349.2 fps at 4 Lines
Binning		2×2 Binning
Pixel Data Format	Mono	Mono 8 / Mono 10 / Mono 12
	Color	GB Bayer 8 / GB Bayer 10 / GB Bayer 12
Electronic Sh	nutter	Global Shutter
Trigger Synchro	onization	Free-Run, Hardware Trigger, Software Trigger or CXP
External Trigger		3.3 V ~ 24.0 V, 10 mA, Logical Level Input, Optically Isolated
Software Trigger		Asynchronous, Programmable via Camera API
Dynamic Range		66 dB @ 12 bit
Gain Control		1×~32×
Black Level Control		0 ~ 255 LSB at 12 bit
Cooling Method		Thermoelectric Peltier Cooling
Cooling Performance		15°C below ambient temperature – Standard cooling with a fan
Dimension / Weight		90 mm $ imes$ 90 mm $ imes$ 145 mm, 1,500 g (with F-mount)
Temperature		Operating: 0°C ~ 40°C, Storage: −40°C ~ 70°C
Lens Mount		F-mount, Custom mount available upon request
Power	External	11 ~ 24 V DC
Power	Dissipation	Typ. 26.0 W
Complian	ice	CE, FCC, KC
API SDK		Vieworks Imaging Solution 7.X

Spectral Response



Ordering Scheme



Connector Specification

Power



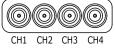
1, 2, 3: +12V DC 4, 5, 6: GND (HR10A-7R-6PB)

Control



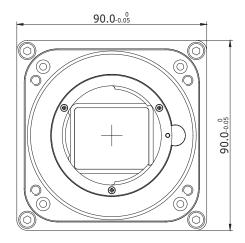
1: Trigger IN+ 2: Trigger IN-3: Strobe Out-(GND) 4: Strobe Out+ (HR10A-7R-4S)

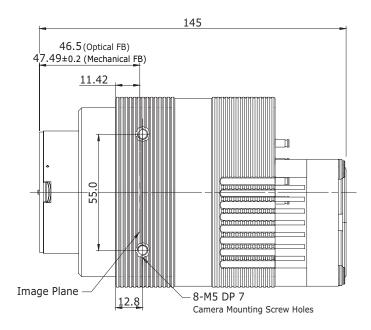
Data Transfer / Communications

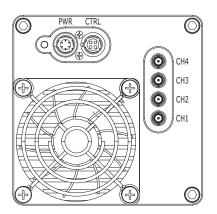


CH1: Master Connection 75 $\Omega,$ DIN 1.0/2.3

Unit: mm







For more information please contact:



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VP-50MX

50 MEGAPIXEL THERMOELECTRIC PELTIER COOLED CAMERA



The VP–50MX, the latest member of the industrial proven VP series, is a 50 megapixel resolution CMOS camera with the CoaXPress interface. The VP–50MX uses the latest 50 megapixel CMOS image sensor (CMV50000) technology from AMS CMOSIS, and offers up to 30.9 frames per second at 7920 × 6004 resolution. This camera uses thermo–electric Peltier (TEC) cooling technology developed for, and used by, many demanding medical market customers. The TEC maintains the operating temperature of the CMOS image sensor at up to about 12 degrees below ambient temperature. This camera provides a stable operating condition or the ability to expose for a long period of time to increase camera sensitivity. Featured with the stable operating capability and high resolution, this camera is ideal for demanding applications such as FPD, PCB and semiconductor inspections.



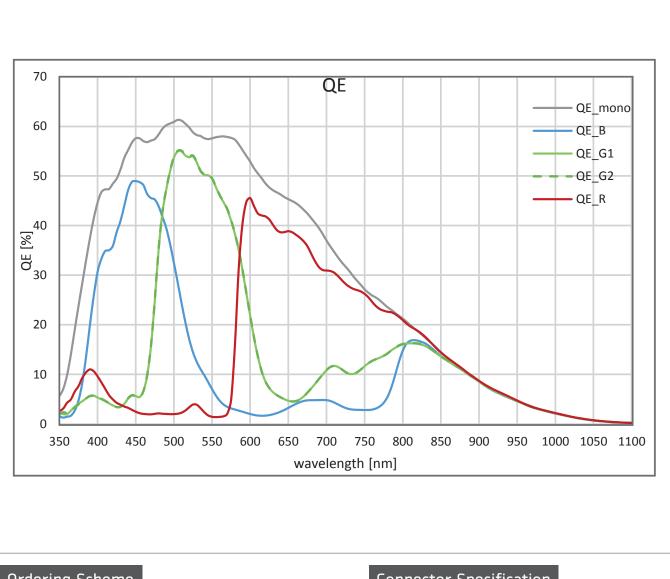
- * 50 Megapixel Resolution (AMS CMOSIS)
- * Thermoelectric Peltier Cooling
- about 12 degrees below ambient temperature
- \star Minimizing the number of hot pixels with TEC
- * CoaXPress Interface up to 30 fps at 25 Gbps using 4 CH
- * Pixel Defect Correction
- * Flat Field Correction
- * DSNU and PRNU Correction

Specifications

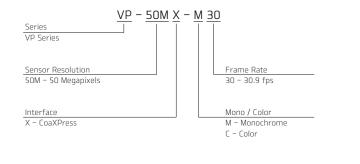
- * Flat Panel Display Inspection
- * PCB Inspection
- * Machine Vision Inspection
- * Microscopy and Metrology

Model		VP-50MX-M/C 30			
Resolution (H $ imes$ V)		7920 × 6004			
Sensor		AMS CMOSIS CMV 50000			
Sensor Size (Optic	al Diagonal)	35 mm (45.72 mm)			
Sensor Tu	Sensor Type High Speed CMOS Image Sensor				
Pixel Size		4.6 μ m $ imes$ 4.6 μ m			
Interfac	e	CoaXPress			
Max. Frame	Rate	1CH: 7.7 fps @ 6.25 Gbps 2CH: 15.5 fps @ 6.25 Gbps 4CH: 30.9 fps @ 6.25 Gbp			
Exposure Time (1 μs step)	1 <i>µ</i> s – 60 s			
Partial Scan (Ma	x. Speed)	3968 fps at 4 Lines			
Divel Data Favorat	Mono	Mono 8 / Mono 10 / Mono 12			
Pixel Data Format	Color	BG Bayer 8 / BG Bayer 10 / BG Bayer 12			
Electronic Shutter		Global Shutter	Global Shutter		
Exposure Mode		Free-Run, Timed and Trigger Width			
Dynamic Range		64 dB			
Gain Control $1 \times \sim 30 \times (1/1024 \text{ step})$					
Black Level Control 0 ~		0 ~ 256 LSB at 12 bit (1 LSB step)	256 LSB at 12 bit (1 LSB step)		
Cooling Method Thermoelectric Peltier Cooling					
Cooling Performance 12°C below ambient temperature – Standard cooling with a fan					
Dimension / Weight		ht 90 mm × 90 mm × 146 mm, 1,400 g			
Temperature		Operating: -5℃ ~ 40℃, Storage: -40℃ ~ 70℃			
Vibration / Shock		3G (20 ~ 200 Hz) XYZ / 10G 6 ms			
Lens Mount		F-mount, Custom mount available upon request			
D	External	10 ~ 24 V DC, Typ. 24.0 W			
Power	PoCXP	Not supported			
Complian	се	CE, FCC, KC			
API SDK		Vieworks Imaging Solution 7.X			

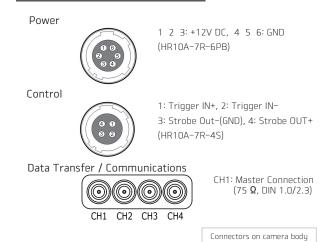
Quantum Efficiency Curves

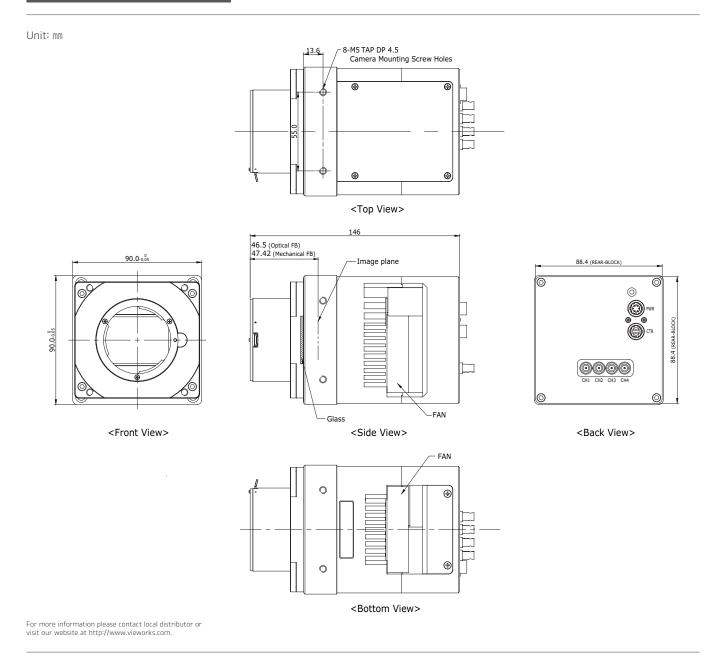


Ordering Scheme



Connector Specification





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